



A Product Line of **Diodes Incorporated** 



# DMN3730U

#### **30V N-CHANNEL ENHANCEMENT MODE MOSFET IN SOT23**

#### Product Summary

V(BR)DSS	Max R <sub>DS(on)</sub>	I <sub>D</sub> Max (Note 5) T <sub>A</sub> = 25°C
30V	460mΩ @ V <sub>GS</sub> = 4.5V	0.94A
30 V	560mΩ @ V <sub>GS</sub> = 2.5V	0.85A

# **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(on)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Load switch
- Portable applications
- **Power Management Functions**

# ESD PROTECTED TO 2kV



SOT23

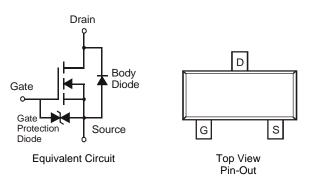
Top View

# **Features and Benefits**

- Low  $V_{\text{GS}(\text{th}),}$  can be driven directly from a battery •
- Low R<sub>DS(on)</sub>
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- ESD Protected Gate 2kV
- Qualified to AEC-Q101 Standards for High Reliability

# **Mechanical Data**

- Case: SOT23 .
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish-Matte Tin.
- Weight: 0.08 grams (approximate)



## Ordering Information (Note 3)

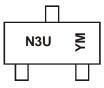
Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN3730U-7	N3U	7	8	3,000

1. No purposefully added lead

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



N3U = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Notes:

Balle Beachley												
Year	201	1	2012		2013	20	14	2015		2016	1	2017
Code	Y		Z		А	I	3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$ (Note 5) $T_A = 85^{\circ}C$ (Note 5) $T_A = 25^{\circ}C$ (Note 4)	I <sub>D</sub>	0.94 0.68 0.75	A
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	10	A

## Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 4)	P	0.45	W
	(Note 5)	PD	0.71	W
Thermal Resistance, Junction to Ambient	(Note 4)	6	275	°C/W
	(Note 5)	R <sub>θJA</sub>	177	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

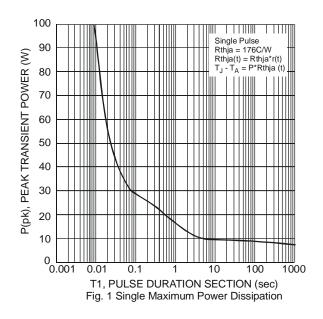
Notes:

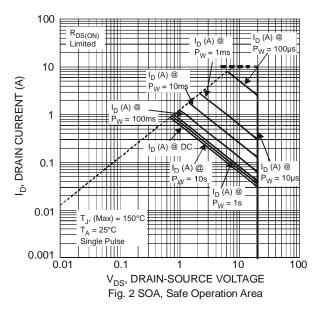
4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout

5. Device mounted on 25mm X 25mm square copper plate with FR-4 substrate PC board, 2oz copper

6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

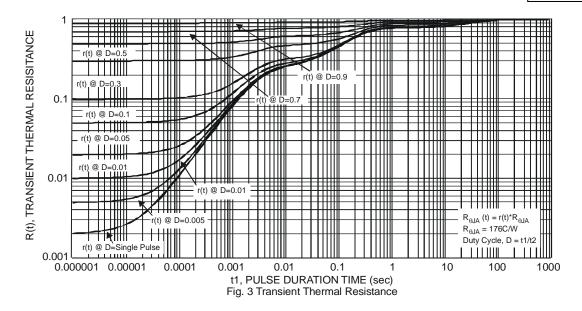
## **Thermal Characteristics**











### Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

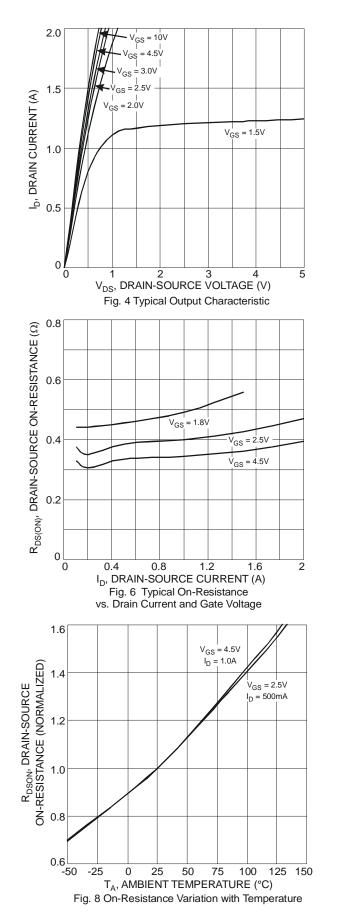
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-	-	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	-	-	3	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.45	-	0.95	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
				460		$V_{GS} = 4.5V, I_D = 200mA$
Static Drain-Source On-Resistance (Note 7)	R <sub>DS(on)</sub>	-	-	- 560	$\mathbf{m}\Omega$	$V_{GS} = 2.5V, I_D = 100mA$
				730		$V_{GS} = 1.8V, I_D = 75mA$
Forward Transfer Admittance	Y <sub>fs</sub>	40	-	-	mS	$V_{DS} = 3V, I_{D} = 10mA$
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 300mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	64.3	-	pF	
Output Capacitance	Coss	-	6.1	-	pF	$V_{DS} = 25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	4.5	-	pF	1 = 1.00012
Gate Resistance	Rg	-	70	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge	Qg	-	1.6	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	-	0.2	-	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$
Gate-Drain Charge	Q <sub>gd</sub>	-	0.2	-	nC	$I_D = 1A$
Turn-On Delay Time	t <sub>D(on)</sub>	-	3.5	-	ns	
Turn-On Rise Time	tr	-	2.8	-	ns	$V_{DS} = 10V, I_D = 1A$
Turn-Off Delay Time	t <sub>D(off)</sub>	-	38	-	ns	$V_{GS} = 10V, R_{G} = 6\Omega$
Turn-Off Fall Time	t <sub>f</sub>	-	13	-	ns	

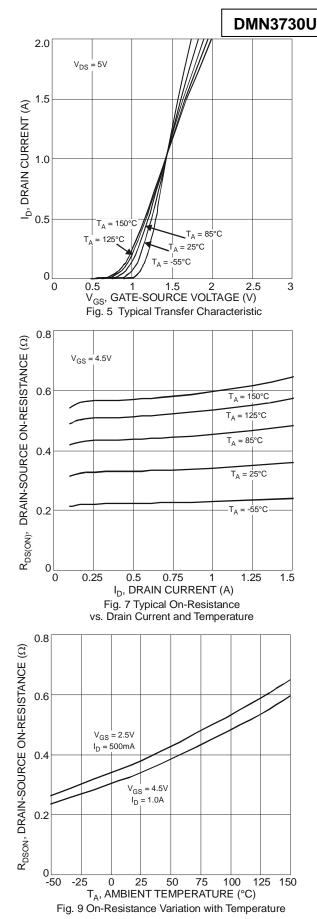
Notes: 7. Measured under pulsed conditions to minimize self-heating effect. Pulse width  $\leq$  300µs; duty cycle  $\leq$  2% 8. For design aid only, not subject to production testing.



A Product Line of Diodes Incorporated



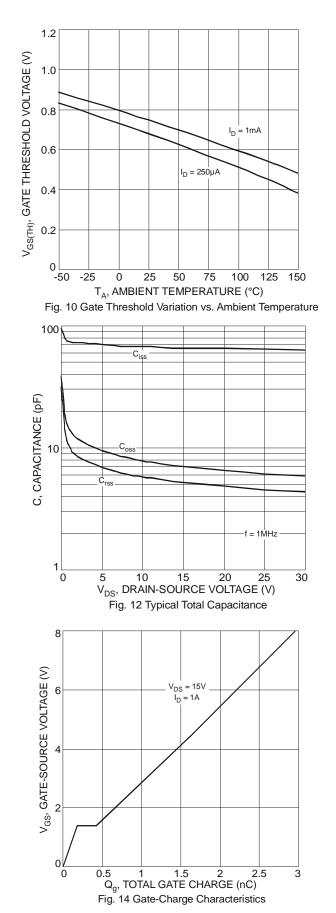


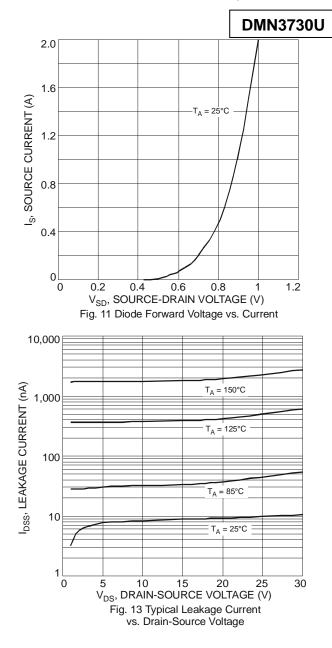




A Product Line of ZETEX **Diodes Incorporated** 



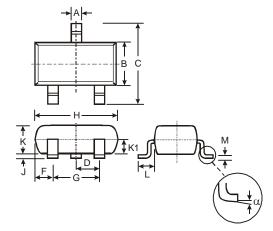






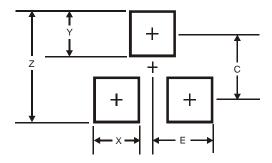


# Package Outline Dimensions



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
с	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	3.00	2.90				
J	0.013	0.10	0.05				
κ	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	-				
All	Dimens	ions in	mm				

# Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35





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